

HfUbg]YbhJc`HJ Y'Gi ddfYggc'fg'fHJGL8 UHJGA YYh

Features

- For surface mounted applications in order to optimize board space
- Low profile package
- Built-in strain relief
- Glass passivated junction
- Low inductance
- Excellent clamping capability
- 600W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycle): 0.01%
- Fast response time
- Typical I_R less than 1µA above 12V
- High Temperature soldering: 260°C/10 seconds at terminals
- Plastic package has underwriters laboratory flammability 94V-0
- Meets MSL level 1, per J-STD-020
- AEC-Q101 qualified (Automotive grade with suffix "Q".)
- Expsemi electronics
- UL Certification:E492977



Mechanical Data

- Case: JEDEC DO-214AA. Molded plastic over glass passivated junction
- Terminal: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode except bi-directional models

Applications

- AC/DC power supply
- I/O interface
- Low frequency signal transmission line

Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Rating	Symbol	Value	Units
Peak pulse power dissipation at 10/1000µs waveform (Note1, Note2, Fig.1)	P_{PPM}	Minimum 600	Watts
Peak pulse current of at 10/1000µs waveform (Note 1, Fig.3)	I_{PPM}	See Table	Amps
Steady state power dissipation at $T_A=50^\circ\text{C}$ (Fig.5)	$P_{M(AV)}$	5.0	Watts
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load, (JEDEC Method) (Note3, Fig.6)	I_{FSM}	100	Amps
Operating junction and Storage Temperature Range.	T_J, T_{STG}	-65 to +150	°C
Typical thermal resistance junction to lead	$R_{\theta JL}$	20	°C/W
Typical thermal resistance junction to ambient	$R_{\theta JA}$	100	°C/W

Notes: 1. Non-repetitive current pulse, per Fig.3 and derated above $T_A=25^\circ\text{C}$ per Fig.2.

2. Mounted on 5.0mm×5.0mm (0.03mm thick) copper pads to each terminal.

3. 8.3ms single half sine-wave, or equivalent square wave, duty cycle=4 pulses per minutes maximum.

Electrical Characteristics (T_A=25°C)

Part Number		Device Marking Code		Reverse Stand-Off Voltage	Breakdown Voltage @I _T	Test Current	Maximum Clamping Voltage @I _{PP}	Peak Pulse Current	Reverse Leakage @V _{RWM}
Unidirectional	Bidirectional	UNI	BI	V _{RWM} (V)	V _{BR} (V)	I _T (mA)	V _C (V)	I _{PP} (A)	I _R (μA)
P6SMB6.8A	P6SMB6.8CA	6V8A	6V8C	5.80	6.45~7.14	10	10.5	58.1	1000
P6SMB7.5A	P6SMB7.5CA	7V5A	7V5C	6.40	7.13~7.88	10	11.3	54.0	500
P6SMB8.2A	P6SMB8.2CA	8V2A	8V2C	7.02	7.79~8.61	10	12.1	50.4	200
P6SMB9.1A	P6SMB9.1CA	9V1A	9V1C	7.78	8.65~9.55	1	13.4	45.5	50
P6SMB10A	P6SMB10CA	10A	10C	8.55	9.50~10.50	1	14.5	42.1	10
P6SMB11A	P6SMB11CA	11A	11C	9.40	10.50~11.60	1	15.6	39.1	5
P6SMB12A	P6SMB12CA	12A	12C	10.20	11.40~12.60	1	16.7	36.5	5
P6SMB13A	P6SMB13CA	13A	13C	11.10	12.40~13.70	1	18.2	33.5	1
P6SMB15A	P6SMB15CA	15A	15C	12.80	14.30~15.80	1	21.2	28.8	1
P6SMB16A	P6SMB16CA	16A	16C	13.60	15.20~16.80	1	22.5	27.1	1
P6SMB18A	P6SMB18CA	18A	18C	15.30	17.10~18.90	1	25.2	24.2	1
P6SMB20A	P6SMB20CA	20A	20C	17.10	19.00~21.00	1	27.7	22.0	1
P6SMB22A	P6SMB22CA	22A	22C	18.80	20.90~23.10	1	30.6	19.9	1
P6SMB24A	P6SMB24CA	24A	24C	20.50	22.80~25.20	1	33.2	18.4	1
P6SMB27A	P6SMB27CA	27A	27C	23.10	25.70~28.40	1	37.5	16.3	1
P6SMB30A	P6SMB30CA	30A	30C	25.60	28.50~31.50	1	41.4	14.7	1
P6SMB33A	P6SMB33CA	33A	33C	28.20	31.40~34.70	1	45.7	13.3	1
P6SMB36A	P6SMB36CA	36A	36C	30.80	34.20~37.80	1	49.9	12.2	1
P6SMB39A	P6SMB39CA	39A	39C	33.30	37.10~41.00	1	53.9	11.3	1
P6SMB43A	P6SMB43CA	43A	43C	36.80	40.90~45.20	1	59.3	10.3	1
P6SMB47A	P6SMB47CA	47A	47C	40.20	44.70~49.40	1	64.8	9.4	1
P6SMB51A	P6SMB51CA	51A	51C	43.60	48.50~53.60	1	70.1	8.7	1
P6SMB56A	P6SMB56CA	56A	56C	47.80	53.20~58.80	1	77.0	7.9	1
P6SMB62A	P6SMB62CA	62A	62C	53.00	58.90~65.10	1	85.0	7.2	1
P6SMB68A	P6SMB68CA	68A	68C	58.10	64.60~71.40	1	92.0	6.6	1
P6SMB75A	P6SMB75CA	75A	75C	64.10	71.30~78.80	1	103.0	5.9	1
P6SMB82A	P6SMB82CA	82A	82C	70.10	77.90~86.10	1	113.0	5.4	1
P6SMB91A	P6SMB91CA	91A	91C	77.80	86.50~95.50	1	125.0	4.9	1
P6SMB100A	P6SMB100CA	100A	100C	85.50	95.00~105.00	1	137.0	4.5	1

Electrical Characteristics (T_A=25°C)

Part Number		Device Marking Code		Reverse Stand-Off Voltage	Breakdown Voltage @I _T	Test Current	Maximum Clamping Voltage @I _{PP}	Peak Pulse Current	Reverse Leakage @V _{RWM}
Unidirectional	Bidirectional	UNI	BI	V _{RWM} (V)	V _{BR} (V)	I _T (mA)	V _C (V)	I _{PP} (A)	I _R (μA)
P6SMB110A	P6SMB110CA	110A	110C	94.00	105.00~116.00	1	152.0	4.0	1
P6SMB120A	P6SMB120CA	120A	120C	102.00	114.00~126.00	1	165.0	3.7	1
P6SMB130A	P6SMB130CA	130A	130C	111.00	124.00~137.00	1	179.0	3.4	1
P6SMB150A	P6SMB150CA	150A	150C	128.00	143.00~158.00	1	207.0	2.9	1
P6SMB160A	P6SMB160CA	160A	160C	136.00	152.00~168.00	1	219.0	2.8	1
P6SMB170A	P6SMB170CA	170A	170C	145.00	162.00~179.00	1	234.0	2.6	1
P6SMB180A	P6SMB180CA	180A	180C	154.00	171.00~189.00	1	246.0	2.5	1
P6SMB200A	P6SMB200CA	200A	200C	171.00	190.00~210.00	1	274.0	2.2	1
P6SMB220A	P6SMB220CA	220A	220C	185.00	209.00~231.00	1	328.0	1.9	1
P6SMB250A	P6SMB250CA	250A	250C	214.00	237.00~263.00	1	344.0	1.8	1
P6SMB300A	P6SMB300CA	300A	300C	256.00	285.00~315.00	1	414.0	1.5	1
P6SMB350A	P6SMB350CA	350A	350C	300.00	332.00~368.00	1	482.0	1.3	1
P6SMB400A	P6SMB400CA	400A	400C	342.00	380.00~420.00	1	548.0	1.1	1
P6SMB440A	P6SMB440CA	440A	440C	376.00	418.00~462.00	1	602.0	1.0	1
P6SMB480A	P6SMB480CA	480A	480C	408.00	456.00~504.00	1	658.0	0.9	1
P6SMB510A	P6SMB510CA	510A	510C	434.00	485.00~535.00	1	698.0	0.9	1
P6SMB530A	P6SMB530CA	530A	530C	450.00	503.50~556.50	1	725.0	0.8	1
P6SMB540A	P6SMB540CA	540A	540C	459.00	513.00~567.00	1	740.0	0.8	1
P6SMB550A	P6SMB550CA	550A	550C	467.00	522.50~577.50	1	760.0	0.8	1

Notes: For bidirectional type having V_{RWM} of 10V and less, the I_R limit is double.

Figure 1. Peak Pulse Power Rating Curve

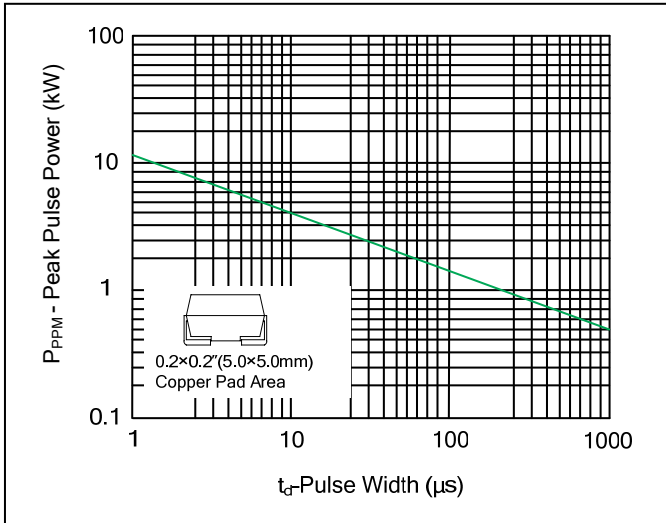


Figure 2. Pulse Derating Curve

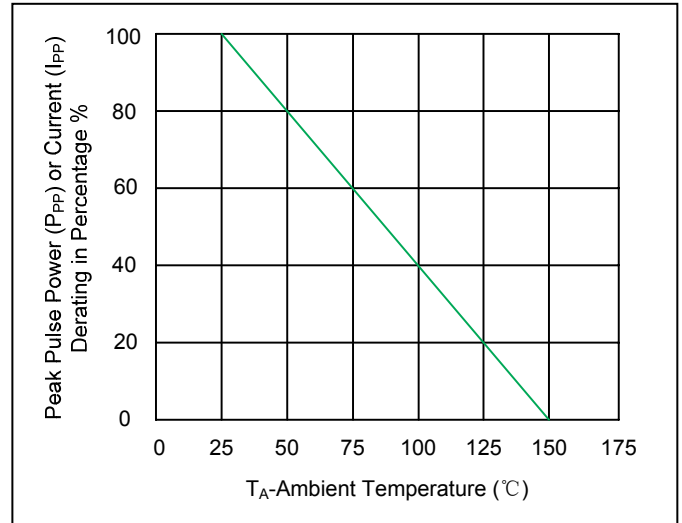


Figure 3. Pulse Waveform

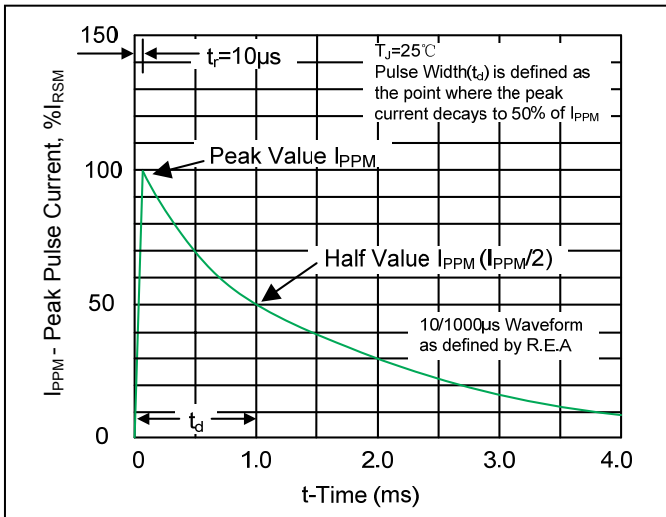


Figure 4. Typical Junction Capacitance

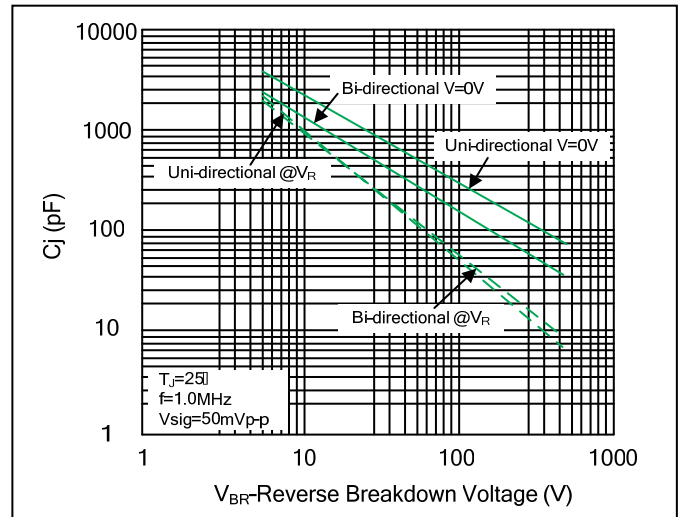


Figure 5. Steady State Power Dissipation Derating Curve

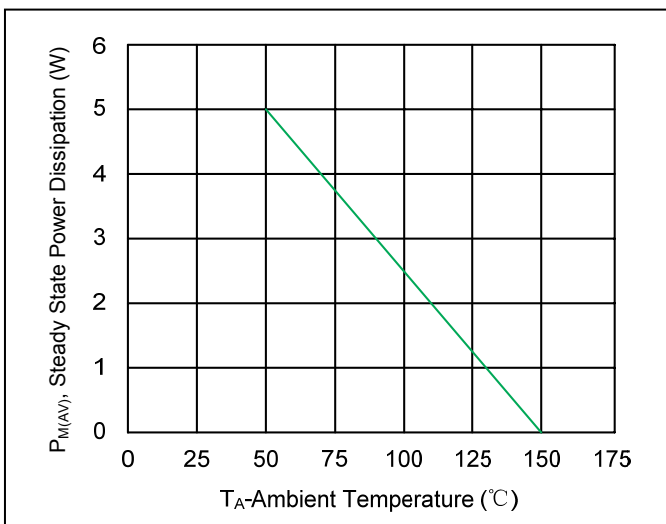
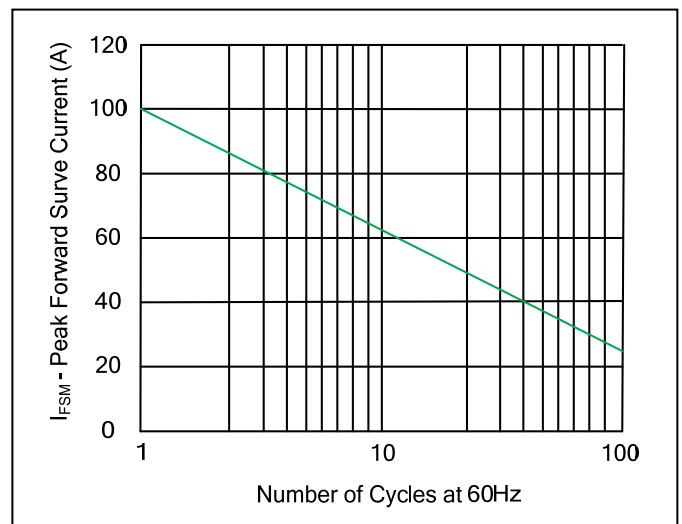


Figure 6. Maximum Non-Repetitive Forward Surge Current Uni-Directional Only



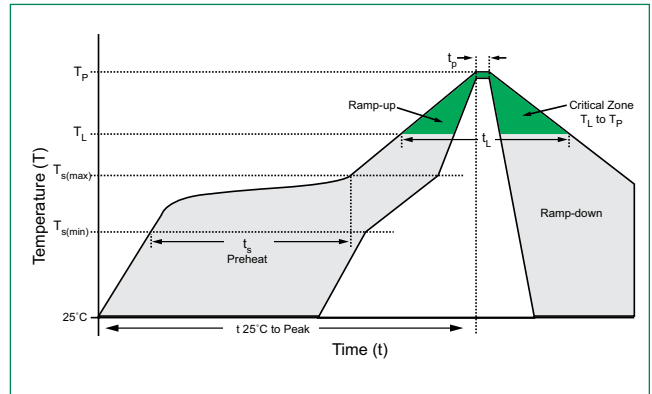
Recommended Soldering Conditions

Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_A) to peak)		3°C/second max
$T_{s(max)}$ to T_A - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_A) (Liquidus)	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C

Physical Specifications

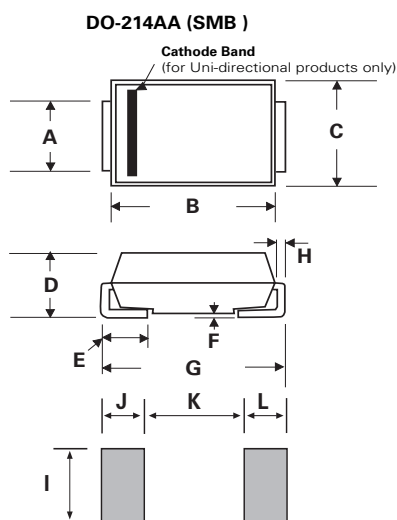
Case	JEDEC DO214AA. Molded plastic body over glass passivated junction
Polarity	Color band denotes cathode except Bidirectional
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102



Environmental Specifications

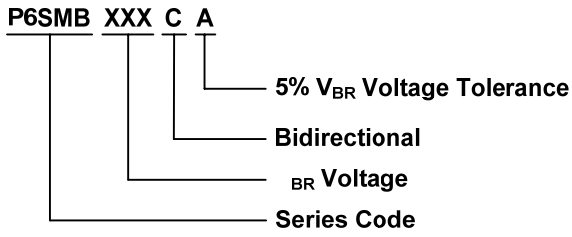
High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

Dimensions

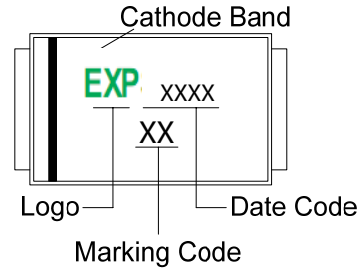


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.075	0.086	1.900	2.200
B	0.160	0.191	4.060	4.850
C	0.130	0.155	3.300	3.940
D	0.083	0.096	2.100	2.440
E	0.030	0.060	0.760	1.520
F	-	0.008	-	0.203
G	0.200	0.220	5.080	5.590
H	0.006	0.012	0.152	0.305
I	0.089	-	2.260	-
J	0.085	-	2.160	-
K	-	0.107	-	2.740
L	0.085	-	2.160	-

Part Numbering System



Part Marking System



Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
P6SMBxxxXX	DO-214AA	3000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

Tape and Reel Specification

